

The listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Currently Amended) A card comprising:
a display device comprising a first semiconductor element comprising a first polycrystalline semiconductor film;
a first thin film integrated circuit comprising a second semiconductor element comprising a second polycrystalline semiconductor film;
a first substrate; and
a second substrate,
wherein the display device is electrically connected to the first thin film integrated circuit,
wherein the thin film integrated circuit and the display device are covered and sealed with a resin between the first substrate and the second substrate of the card, and
wherein the first substrate and the second substrate comprise a plastic material.
2. (Original) A card according to claim 1, wherein the card has a thickness from 0.05 mm through 1.5 mm.
3. (Previously Presented) A card according to claim 1, wherein the display device is a passive matrix type display device.
4. (Original) A card according to claim 1, wherein the display device is an active matrix type.

5. (Previously Presented) A card according to claim 1, further comprising:
a second thin film integrated circuit,
wherein the first and second thin film integrated circuits are laminated.

6.-8. (Canceled)

9. (Previously Presented) A card according to claim 1, wherein the display device is a liquid crystal display device.

10. (Canceled)

11. (Previously Presented) A card according to claim 1, wherein the display device is a light emitting device.

12. (Canceled)

13. (Previously Presented) A card according to claim 1, wherein the card is an ID card.

14. (Canceled)

15. (Previously Presented) A card according to claim 1, wherein the card is a semi-hard card.

16. (Canceled)

17. (Previously Presented) A card according to claim 1, wherein the card is an IC card.

18.-19. (Canceled)